# 1.8V Drive Nch+SBD MOSFET

# **QS5U34**

# ●Structure

Silicon N-channel MOSFET Schottky Barrier DIODE

#### ● Features

- 1) The QS5U34 combines Nch MOSFET with a Schottky barrier diode in a single TSMT5 package.
- 2) Low on-state resistance with fast switching.
- 3) Low voltage drive (1.8V).
- 4) The Independently connected Schottky barrier diode has low forward voltage.

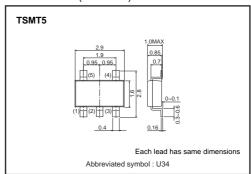
# Applications

Load switch, DC / DC conversion

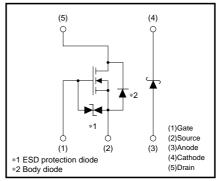
# Packaging specifications

	Package	Taping
Туре	Code	TR
	Quantity (pcs)	3000
QS5U34		0

# ●Dimensions (Unit:mm)



# ●Equivalent circuit





# ● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter	Symbol	Limits	Unit				
Drain-source voltage	V <sub>DSS</sub>	20	V				
Gate-source voltage		V <sub>GSS</sub>	10	V			
Drain current	Continuous	lσ	±1.5	Α			
Diam current	Pulsed	I <sub>DP</sub> *1	±3.0	Α			
Source current	Continuous	Is	0.6	Α			
(Body diode)	Pulsed	I <sub>SP</sub> *1	2.4	Α			
Channel temperature	Tch	150	°C				
Power dissipation	P <sub>D</sub> *3	0.9	W/ELEMENT				
<di></di>							
Repetitive peak reverse volt	VRM	30	V				
Reverse voltage	$V_R$	20	V				
Forward current	l <sub>F</sub>	0.5	Α				
Forward current surge peak	I <sub>FSM</sub> *2	2.0	А				
Junction temperature	Tj	150	°C				
Power dissipation	P <sub>D</sub> *3	0.7	W/ELEMENT				
<mosfet and="" di=""></mosfet>							
Total power dissipation	P <sub>D</sub> *3	1.25	W / TOTAL				
Range of Storage temperatu	Tstg	-55 to +150	°C				

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 60Hz•1cyc. \*3 Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Gate-source leakage	I <sub>GSS</sub>	-	_	10	μΑ	V <sub>GS</sub> =10V / V <sub>DS</sub> =0V	
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	20	_	_	V	I <sub>D</sub> =1mA, / V <sub>GS</sub> =0V	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	V <sub>DS</sub> =20V / V <sub>GS</sub> =0V	
Gate threshold voltage	VGS (th)	0.3	_	1.3	٧	Vps=10V / Ip=1mA	
0		-	130	180	mΩ	I <sub>D</sub> =1.5A, V <sub>GS</sub> =4.5V	
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	_	170	240	mΩ	I <sub>D</sub> =1.5A, V <sub>GS</sub> =2.5V	
resistance		_	220	310	mΩ	I <sub>D</sub> =0.8A, V <sub>GS</sub> =1.8V	
Forward transfer admittance	Y <sub>fs</sub> *	1.6	-	_	S	Vps=10V, Ip=1.5A	
Input capacitance	Ciss	_	110	_	pF	V <sub>DS</sub> =10V	
Output capacitance	Coss	_	18	_	pF	V <sub>GS</sub> =0V	
Reverse transfer capacitance	Crss	_	15	_	pF	f=1MHz	
Turn-on delay time	td (on) *	_	5	_	ns	ID=1.0A	
Rise time	tr *	_	5	_	ns	V <sub>DD</sub> ≒10V	
Turn-off delay time	t <sub>d (off)</sub> *	_	20	_	ns	V <sub>GS</sub> =4.5V R <sub>L</sub> =10Ω	
Fall time	t <sub>f</sub> *	-	3	_	ns	R <sub>G</sub> =10Ω	
Total gate charge	Q <sub>g</sub> *	-	1.8	2.5	nC	V <sub>DD</sub> ≒10V	
Gate-source charge	Q <sub>gs</sub> *	-	0.3	-	nC	V <sub>GS</sub> =4.5V	
Gate-drain charge	Q <sub>gd</sub> *	_	0.3	_	nC	I <sub>D</sub> =1.5A	

# <MOSFET>Body diode (source-drain)

Forward voltage	Vsd	_	_	1.2	V	I <sub>S</sub> =0.6A / V <sub>GS</sub> =0V

<Di>

Forward voltage	VF	_	_	0.36	V	I <sub>F</sub> =0.1A
		_	_	0.47	V	I <sub>F</sub> =0.5A
Reverse current	IR	_	_	100	uΑ	V <sub>R</sub> =20V



#### •Electrical characteristic curves

<MOSFET>

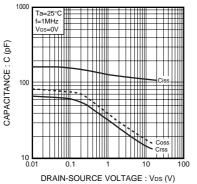


Fig.1 Typical Capacitance vs. Drain-Source Voltage

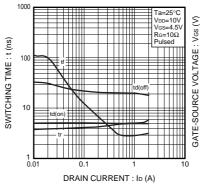


Fig.2 Switching Characteristics

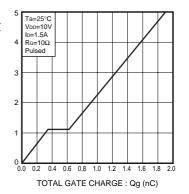


Fig.3 Dynamic Input Characteristics

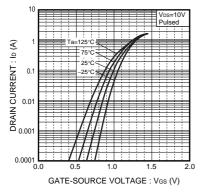


Fig.4 Typical Transfer Characteristics

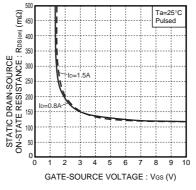


Fig.5 Static Drain-Source On-State Resistance vs. Gate-source Voltage

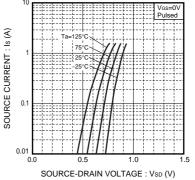


Fig.6 Source Current vs. Source-Drain Voltage

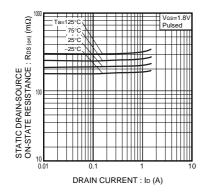


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current ( I )

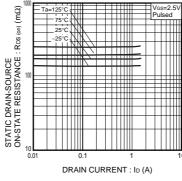


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current ( II )

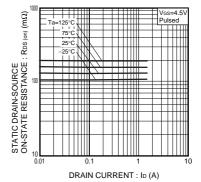
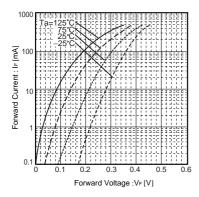


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current ( III )





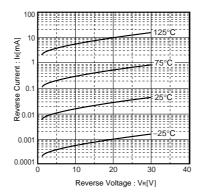


Fig.10 Forward Temperature Characteristics

Fig.11 Reverse Temperature Characteristics



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JAPAN	USA	EU	CHINA	
CLASSⅢ	CL ACCTI	CLASS II b	CLASSII	
CLASSIV	CLASSII	CLASSⅢ		

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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